

K_p	Kutateladze number
L	reference length, m
L_c	condenser length, m
L_e	evaporator length, m
L_{eff}	effective length, m
L_t	overall length of the heat pipe, m
$m_1, m_2,$ m_3, m_4	constants in Eq. (25)
N_g	number of grooves
Nu	Nusselt number
p	perimeter, m
P	precision limit contribution
P_o	Poiseuille number
P_{sat}	saturation temperature, Pa
Q	heat input power, W
q_c	heat flux at the condenser section, W/m ²
q_{ev}	heat flux at the evaporator section, W/m ²
r	gas constant, J/kg.K
R_1	thermal resistance due to thermal conduction through the evaporator wall, K/W
R_2	thermal resistance due to evaporation, K/W
R_3	liquid-vapor interfacial thermal resistance, K/W
R_4	thermal resistance due to the exchanges between the vapor and the heat pipe wall, K/W
R_5	liquid-vapor interfacial thermal resistance, K/W
R_6	thermal resistance due to condensation, K/W
R_7	thermal resistance due to thermal conduction through the condensation wall, K/W
R_8	thermal resistance due thermal conduction along the heat pipe, K/W
r_c	capillary radius, m
Re	Reynolds number
R_{th}	heat pipe overall thermal resistance, K/W
R_{tha}	thermal resistance of the adiabatic zone, K/W
R_{thc}	condenser thermal resistance, K/W
R_{thcond}	thermal resistance of condensation, K/W
R_{thev}	evaporator thermal resistance, K/W
R_{thevap}	thermal resistance of evaporation, K/W
$R_{thwallc}$	thermal resistance of the condenser wall, K/W
$R_{thwallev}$	thermal resistance of the evaporator wall, K/W
S_g	groove spacing, m
\bar{T}_{ad}	average temperature of the adiabatic zone, °C
\bar{T}_c	average temperature of the condenser, °C
\bar{T}_{ev}	average temperature of the evaporator, °C
T_f	film temperature, °C
T_{hs}	heat sink temperature, °C
T_w	wall temperature, °C
T_{sat}	saturation temperature, °C
t_w	wall thickness, m
W_{gb}	width at the base of the groove, m

W_{gt}	width at the top of the groove, m
x_o	constant defined by Eqns. (40) and (41)

Greek symbols

α	angle defined in Figure 2, °
β	angle defined in Figure 2, °
Δh_v	latent heat of vaporization, J/kg
ΔP_c	capillary pressure, Pa
ΔP_g	hydrostatic pressure, Pa
ΔP_l	liquid pressure loss, Pa
ΔP_v	vapor pressure loss, Pa
$\Delta \bar{T}_c$	average temperature difference between the condenser and the adiabatic sections, K
$\Delta \bar{T}_{ev}$	average temperature difference between the evaporator and adiabatic sections, K
$\Delta \bar{T}_{hp}$	average temperature difference between the evaporator and condenser sections, K
	angle defined in Figure 3, °
θ	contact angle, °
λ	thermal conductivity, W/m.K
μ	dynamic viscosity, kg·m ⁻¹ .s ⁻¹
ν	kinematic viscosity, m/s ²
ρ	density, kg/m ³
σ	surface tension, N/m
φ	porosity

Subscripts

ad	adiabatic
c	condenser, condensation
cond	condensation
e	evaporator
ev	evaporator, evaporation
evap	evaporation
g	groove, hydrostatic
gb	groove bottom
gt	groove top
hp	heat pipe
hs	heat sink
i	inner
l	liquid
max	maximum
o	outer
sat	saturation
t	overall
v	vapor
w	wall